



N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^b			
30	0.0095 at V _{GS} = 10 V	63 ^b			
30	0.014 at V _{GS} = 4.5 V	52 ^b			

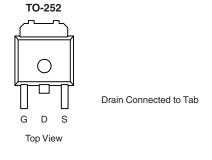
FEATURES

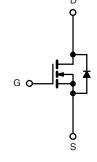
- TrenchFET® Power MOSFET
- Optimized for High- or Low-Side
- 100 % R_g Tested



APPLICATIONS

- DC/DC Converters
- · Synchronous Rectifiers





Ordering Information: SUD50N03-09P

SUD50N03-09P-E3 (Lead (Pb)-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	30	.,			
Gate-Source Voltage	V _{GS}	± 20	V			
	T _C = 25 °C		63 ^b			
Continuous Drain Current ^a	T _C = 100 °C	I _D	44.5 ^b			
Pulsed Drain Current	I _{DM}	50	Α			
Continuous Source Current (Diode Conduction) ^a	I _S	5				
Avalanche Current L = 0.1 mH		I _{AS}	35			
Single Pulse Avalanche Energy	L = 0.1 IIII1	E _{AS}	61	mJ		
Maximum Dayyar Discination	T _C = 25 °C	P _D	65.2	w		
Maximum Power Dissipation	T _A = 25 °C		7.5 ^a] vv		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manines de Anabian de Anabian de	t ≤ 10 s	R _{thJA}	16	20	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		40	50		
Maximum Junction-to-Case		R _{thJC}	1.8	2.3		

Notes:

- a. Surface Mounted on FR4 board, $t \le 10 \text{ s.}$
- b. Based on maximum allowable Junction Temperature, package limitation current is 50 A.
- * Pb containing terminations are not RoHS compliant, exemptions may apply.

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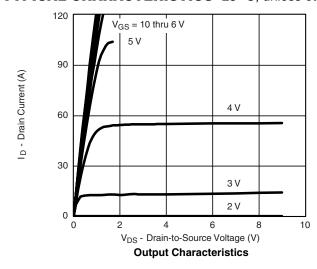
SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0		3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	lace	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	uA I	
Zero date voltage Drain Guirent	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		0.0076	0.0095	Ω	
Drain-Source On-State Resistance ^b	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 125 ^{\circ}\text{C}$			0.015		
		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.0115	0.014		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 20 A	20			S	
Dynamic ^a							
Input Capacitance	C _{iss}			2200		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		410			
Reverse Transfer Capacitance	C _{rss}			180			
Total Gate Charge ^c	Qg			11	16		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 50 \text{ A}$		7.5		nC	
Gate-Drain Charge ^c	Q _{gd}			5.0		1	
Gate Resistance	R_g		0.5	1.5	2.1	Ω	
Turn-On Delay Time ^c	t _{d(on)}			9	15		
Rise Time ^c	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 0.3 \Omega$		15	25	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		22	35	115	
Fall Time ^c	t _f			8	12		
Source-Drain Diode Ratings and Characteristic T _C = 25 °C							
Pulsed Current	I _{SM}				100	Α	
Diode Forward Voltage ^b	V_{SD}	$I_F = 50 \text{ A}, V_{GS} = 0 \text{ V}$		1.2	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 50 A, di/dt = 100 A/μs		35	70	ns	

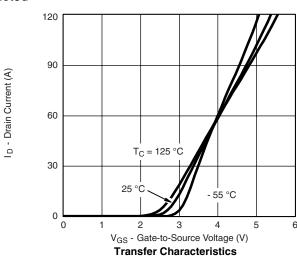
Notes:

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

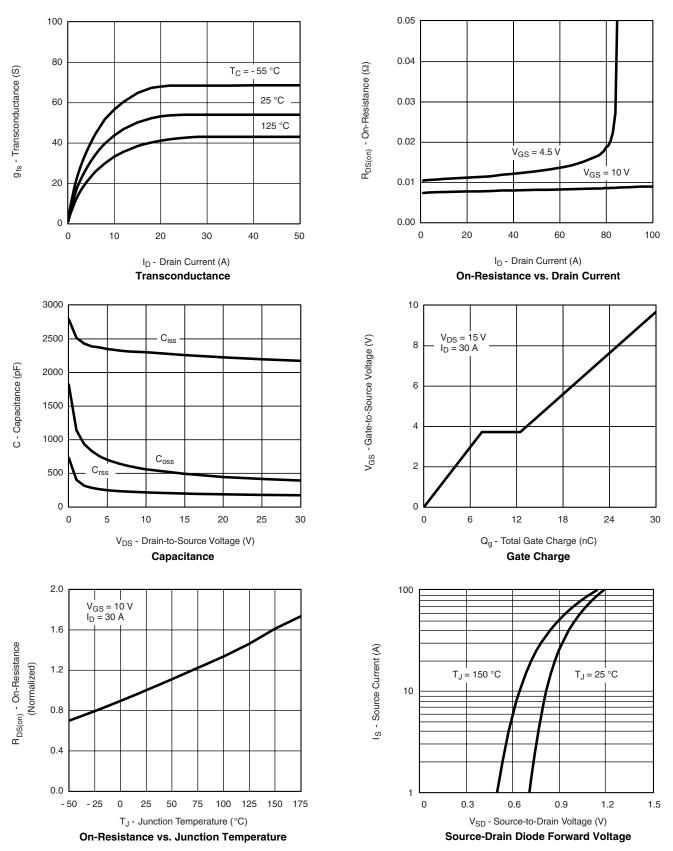
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







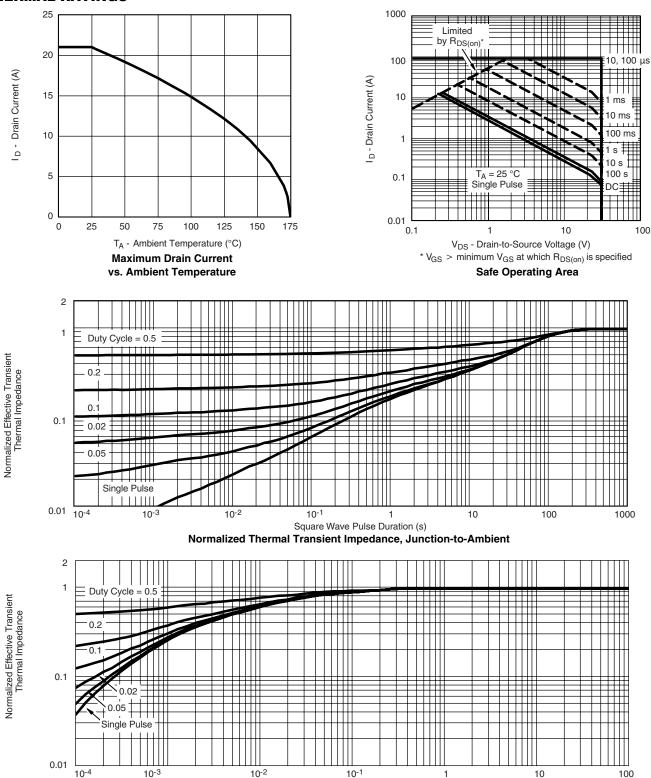
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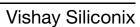
THERMAL RATINGS



Square Wave Pulse Duration (s)

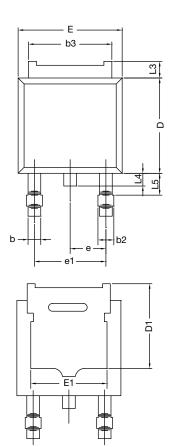
Normalized Thermal Transient Impedance, Junction-to-Case

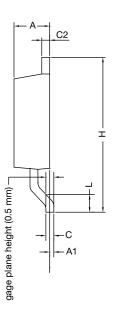
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71856.





TO-252AA Case Outline



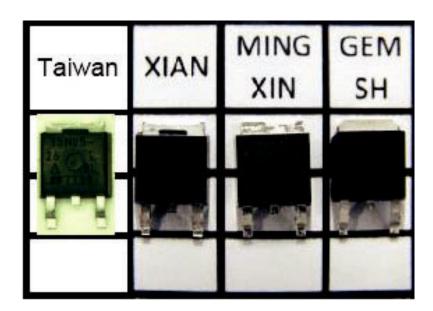


	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	=	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T13-0359-Rev. O, 03-Jun-13					

DWG: 5347

Notes

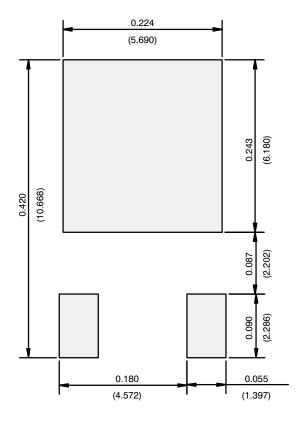
- Dimension L3 is for reference only.
- Xi'an, Mingxin, and GEM SH actual photo.



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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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